

Product /Process Change Notification

Doc: PCN-20250100

Issue Date:2025/4/21

PCN Originator/ Technical Contact:

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Change Type:

Change MFP PTR bonding type

Change Content:

1. Change PTR bonding type from Forward bond to Reverse bond with BSOB

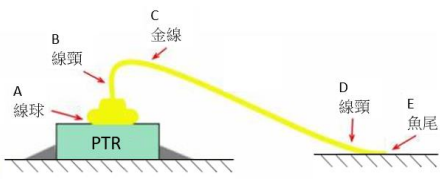
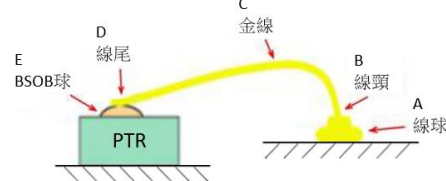
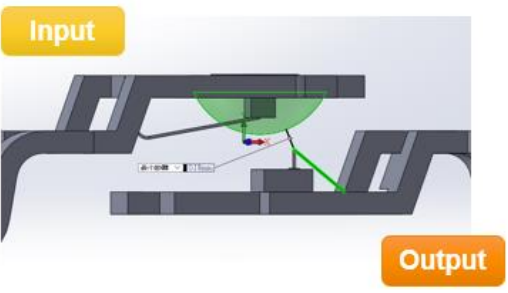
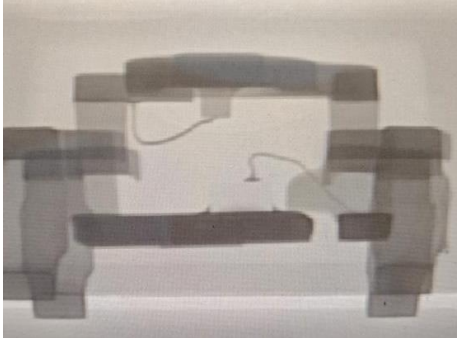
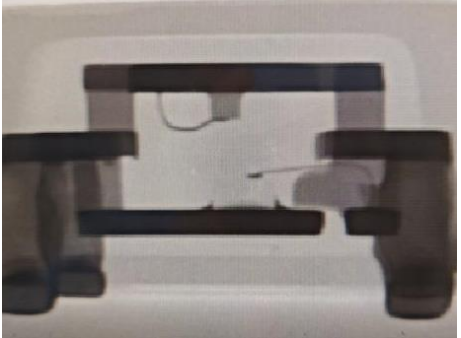
Parts Affected:

- LTV-356T series
- LTV-357T series

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Change Detail Description:

- Description

	Before	After
PTR Bonding type	Forward bond	Reverse bond with BSOB
		
Isolation distance	IR Reverse bond + PTR Forward bond	IR Reverse bond + PTR Reverse bond with BSOB
		
Package		

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- Verification

Trial run report	RA report
 MFP PTR 反打 BSOP.xlsx	 C70CZO25003%2 0%20LTV-356T-C'

Reasons of Change:

Increase the isolation distance from input to output.

Effective Date of Change:

Aug, 2025

Availability of Sample and Datasheet :

Now

Customer Approval Portion :

* **Approved** (_____) ,

Remark : _____

* **Rejected** (_____) ,

Reason : _____

Sincerely yours,

PM / OPS PDD1 Coupler
Lite-On Technology Corp.